TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)/w.DataSheet4U.com

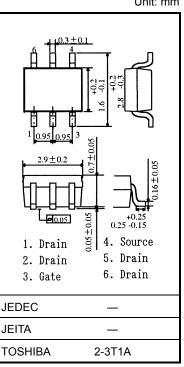
# **TPC6103**

#### Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance:  $RDS(ON) = 29 m\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 13 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -12 \ V)$
- Enhancement mode:  $V_{th} = -0.5$  to -1.2 V
  - $(V_{DS} = -10 \text{ V}, I_D = -200 \text{ }\mu\text{A})$

#### Maximum Ratings (Ta = 25°C)

Characteris	tics	Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	-12	V
Drain-gate voltage (R <sub>G</sub>	<sub>S</sub> = 20 kΩ)	V <sub>DGR</sub>	-12	V
Gate-source voltage		V <sub>GSS</sub>	±8	V
Durain aurorat	DC (Note 1)	Ι <sub>D</sub>	-5.5	А
Drain current	Pulse (Note 1)	I <sub>DP</sub>	-22	A
Drain power dissipation (t = 5 s) (Note 2a)		PD	2.2	W
Drain power dissipation (t = 5 s) (Note 2b)		PD	0.7	W
Single pulse avalanche	energy (Note 3)	E <sub>AS</sub>	5.3	mJ
Avalanche current		I <sub>AR</sub>	-2.75	А
Repetitive avalanche e	nergy (Note 4)	E <sub>AR</sub>	0.22	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature ra	inge	T <sub>stg</sub>	-55~150	°C



Weight: 0.011 g (typ.)

#### **Circuit Configuration**

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R <sub>th (ch-a)</sub>	56.8	°C/W	
$\begin{array}{l} \mbox{Thermal resistance, channel to} \\ \mbox{ambient } (t=5 \mbox{ s}) \mbox{ (Note 2b)} \end{array}$	R <sub>th (ch-a)</sub>	178.5	°C/W	

Note 1, (ote 2, Note 3, Note 4 and Note 5: See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.

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Unit: mm

### Electrical Characteristics (Ta = 25°C)

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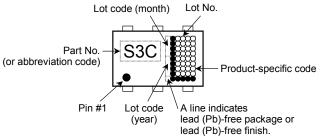
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 8~V,~V_{DS}=0~V$	_		±10	μA	
Drain cut-off current		I <sub>DSS</sub>	$V_{DS} = -12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_	_	-10	μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10$ mA, $V_{GS} = 0$ V	-12		_	V	
		V (BR) DSX	$I_D = -10$ mA, $V_{GS} = 8$ V	-4	_	_	v	
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = -10 \ V, \ I_D = -200 \ \mu A$	-0.5		-1.2	V	
Drain-source ON resistance		R <sub>DS (ON)</sub>	$V_{GS} = -1.8 \text{ V}, I_D = -1.4 \text{ A}$	_	65	90		
		R <sub>DS (ON)</sub>	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$	_	42	55	mΩ	
		R <sub>DS (ON)</sub>	$V_{GS} = -4.5 \text{ V}, \text{ I}_D = -2.8 \text{ A}$	_	29	35		
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$	6.5	13	_	S	
Input capacitance		C <sub>iss</sub>		_	1520	_	pF	
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V},  V_{GS} = 0 \text{ V},  f = 1 \text{ MHz}$	_	330	_		
Output capacitance		C <sub>oss</sub>		_	380	_		
Switching time	Rise time	tr	, 0VJ	_	9.5	_	ns	
	Turn-on time	t <sub>on</sub>	$V_{GS} \xrightarrow{0 V} I_D = -2.8 \text{ A}$	_	16	_		
	Fall time	t <sub>f</sub>	R <sup>1</sup> = 2.1	_	28	_		
	Turn-off time	t <sub>off</sub>	$V_{DD}\simeq -6~V \label{eq:VDD}$ Duty $\leq$ 1%, $t_W=$ 10 $\mu s$	_	74	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -10 \text{ V}, \text{ V}_{GS} = -5 \text{ V},$		20	_		
Gate-source charge		Q <sub>gs</sub>	$I_{\rm D} = -5.5 \rm{A}$	_	15		nC	
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	5			

#### Source-Drain Ratings and Characteristics (Ta = 25°C)

Charact	Characteristics Symbol		Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I <sub>DRP</sub>	-	_	_	-22	А
Forward voltage (diode) V <sub>DSF</sub>		V <sub>DSF</sub>	$I_{DR} = -5.5 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

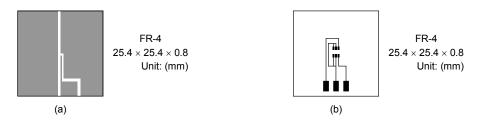
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#### Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s) (b) Device mounted on a glass-epoxy board (b) (t = 5 s)

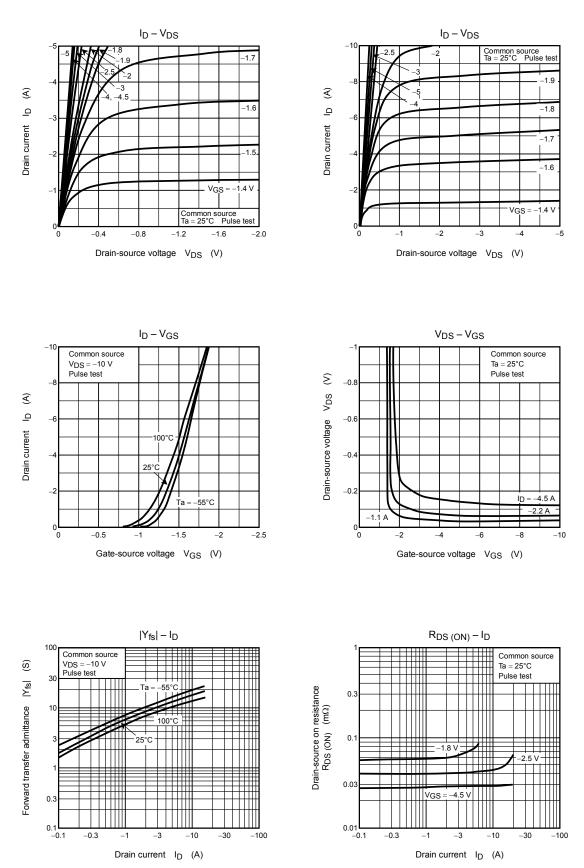


Note 3:  $V_{DD} = -10$  V,  $T_{ch} = 25^{\circ}C$  (initial), L = 0.5 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -2.75$  A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature Note 5: • on lower left of the marking indicates Pin 1.

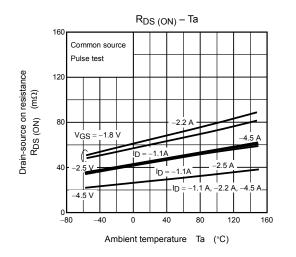
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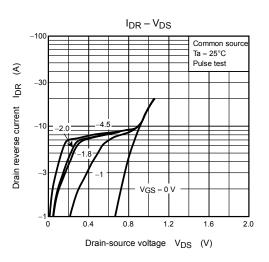
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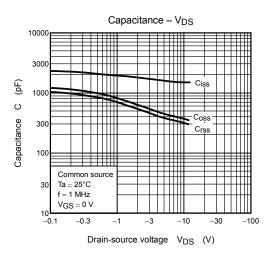


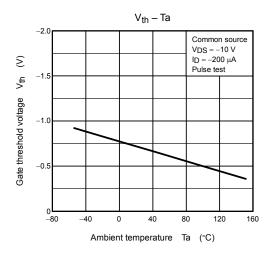
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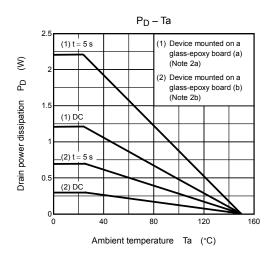
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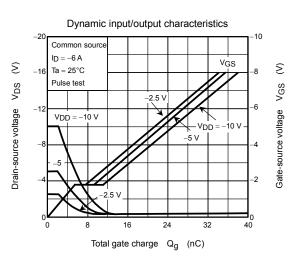




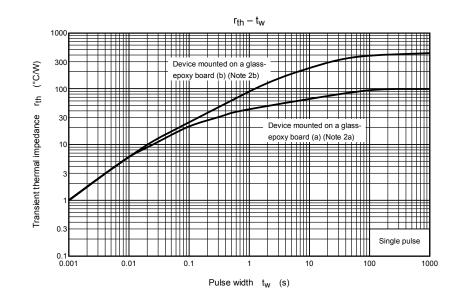




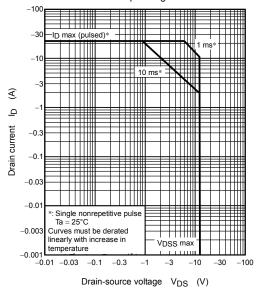




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Safe operating area



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